



#### **General Description**

The WST3407 is the highest performance trench P-ch MOSFET with extreme high cell density , which provide excellent RDSON and gate charge for most of the small power switching and load switch applications.

The WST3407 meet the RoHS and Green Product requirement with full function reliability approved.

#### Features

- Advanced high cell density Trench technology
- Super Low Gate Charge
- Excellent CdV/dt effect decline
- Green Device Available

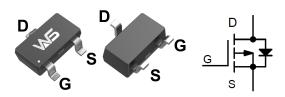
#### **Product Summery**

BVDSS	RDSON	ID
-30V	41mΩ	-5.8A

#### Applications

- High Frequency Point-of-Load Synchronous Buck Converter for MB/NB/UMPC/VGA
- Networking DC-DC Power System
- Load Switch

#### SOT-23-3L Pin Configuration



#### Rating Symbol **Parameter** Units **Steady State** 10s $V_{DS}$ Drain-Source Voltage -30 V Gate-Source Voltage ±20 V $V_{GS}$ Continuous Drain Current, V<sub>GS</sub> @ -10V<sup>1</sup> -6.3 I<sub>D</sub>@T<sub>C</sub>=25℃ -5.8 А Continuous Drain Current, V<sub>GS</sub> @ -10V<sup>1</sup> I<sub>D</sub>@T<sub>C</sub>=70℃ -4.5 -3.5 А Pulsed Drain Current<sup>2</sup> -20 А I<sub>DM</sub> P<sub>D</sub>@T<sub>A</sub>=25℃ Total Power Dissipation<sup>3</sup> 1.32 W 1 Total Power Dissipation<sup>3</sup> 0.64 W P<sub>D</sub>@T<sub>A</sub>=70℃ 0.84 Storage Temperature Range -55 to 150 °C $\mathsf{T}_{\mathsf{STG}}$ **Operating Junction Temperature Range** -55 to 150 °C ТJ

#### Thermal Data

Symbol	Parameter	Тур.	Max.	Unit
R <sub>θJA</sub>	Thermal Resistance Junction-Ambient <sup>1</sup>		125	°C/W
R <sub>0JA</sub>	Thermal Resistance Junction-Ambient $^{1}$ (t ≤10s)		95	°C <b>/W</b>
R <sub>θJC</sub>	Thermal Resistance Junction-Case <sup>1</sup>		80	°C/W

#### Absolute Maximum Ratings



WST3407

**P-Ch MOSFET** 

#### Electrical Characteristics (T<sub>J</sub>=25 °C, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	$V_{GS}$ =0V , I <sub>D</sub> =-250uA	-30			V
$\triangle BV_{DSS} / \triangle T_J$	BV <sub>DSS</sub> Temperature Coefficient	Reference to 25 $^\circ\!\!{\rm C}$ , I_D=-1mA		-0.023		V/℃
R <sub>DS(ON)</sub>	Static Drain-Source On-Resistance <sup>2</sup>	V <sub>GS</sub> =-10V , I <sub>D</sub> =-3A		41	52	mΩ
		V <sub>GS</sub> =-4.5V , I <sub>D</sub> =-2A		62	90	
V <sub>GS(th)</sub>	Gate Threshold Voltage	—V <sub>GS</sub> =V <sub>DS</sub> , I <sub>D</sub> =-250uA	-1.2	-1.8	-2.5	V
$ riangle V_{GS(th)}$	V <sub>GS(th)</sub> Temperature Coefficient			4		mV/℃
	Drain Source Lookage Current	V <sub>DS</sub> =-24V , V <sub>GS</sub> =0V , T <sub>J</sub> =25°C		-1		
I <sub>DSS</sub>	Drain-Source Leakage Current	$V_{DS}$ =-24V , $V_{GS}$ =0V , $T_{J}$ =55 $^{\circ}\mathrm{C}$			-5	uA
I <sub>GSS</sub>	Gate-Source Leakage Current	$V_{GS}=\pm20V$ , $V_{DS}=0V$			±100	nA
gfs	Forward Transconductance	V <sub>DS</sub> =-5V , I <sub>D</sub> =-3A		11		S
Qg	Total Gate Charge (-4.5V)	V <sub>DS</sub> =-15V , V <sub>GS</sub> =-4.5V , I <sub>D</sub> =-3A		6.4	9.0	
Q <sub>gs</sub>	Gate-Source Charge			2.3	3.2	nC
Q <sub>gd</sub>	Gate-Drain Charge			1.9	2.7	
T <sub>d(on)</sub>	Turn-On Delay Time			2.8	5.6	
Tr	Rise Time	$V_{DD}$ =-15V , $V_{GS}$ =-10V , $R_{G}$ =3.3 $\Omega$ ,		8.4	15.1	
T <sub>d(off)</sub>	Turn-Off Delay Time	I <sub>D</sub> =-3A		39	78.0	ns
	Fall Time			6	12.0	
C <sub>iss</sub>	Input Capacitance			583	816	
Coss	Output Capacitance	V <sub>DS</sub> =-15V , V <sub>GS</sub> =0V , f=1MHz		100	140	pF
C <sub>rss</sub>	Reverse Transfer Capacitance	<u> </u>		80	112	

#### **Diode Characteristics**

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
ls	Continuous Source Current <sup>1,4</sup>				-2	А
I <sub>SM</sub>	Pulsed Source Current <sup>2,4</sup>	V <sub>G</sub> =V <sub>D</sub> =0V , Force Current			-20	А
V <sub>SD</sub>	Diode Forward Voltage <sup>2</sup>	V <sub>GS</sub> =0V , I <sub>S</sub> =-1A , T <sub>J</sub> =25℃			-1	V
trr	Reverse Recovery Time			11		nS
Q <sub>rr</sub>	Reverse Recovery Charge	I⊧=-3A , dI/dt=100A/µs , Tյ=25℃		5.3		nC

Note :

1. The data tested by surface mounted on a 1 inch<sup>2</sup> FR-4 board with 2OZ copper,t<10sec.

2.The data tested by pulsed , pulse width  $\leq$  300us , duty cycle  $\leq$  2%

3.The power dissipation is limited by 150  $^\circ\!\!\mathbb{C}$  junction temperature

4. The data is theoretically the same as  $I_{\text{D}}$  and  $I_{\text{DM}}$  , in real applications , should be limited by total power dissipation.



## WST3407

### P-Ch MOSFET

**Typical Characteristics** 

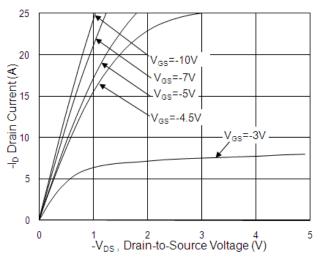


Fig.1 Typical Output Characteristics

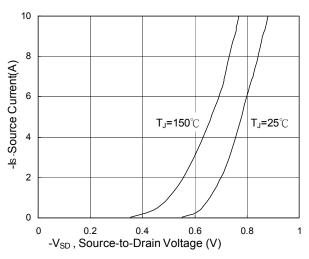


Fig.3 Forward Characteristics of Reverse

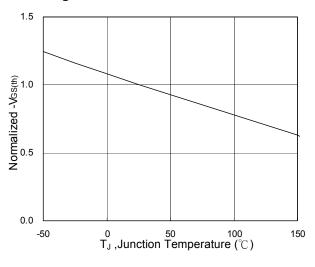


Fig.5 Normalized  $V_{GS(th)}$  vs.  $T_J$ 

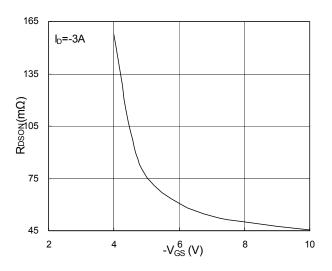


Fig.2 On-Resistance v.s Gate-Source

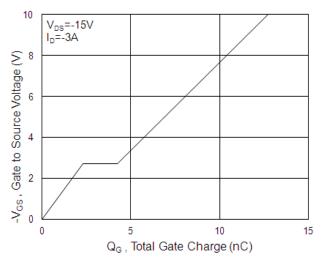


Fig.4 Gate-Charge Characteristics

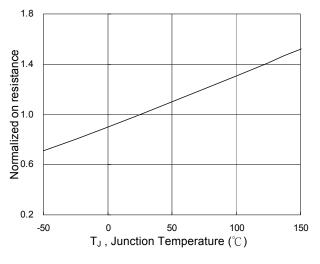
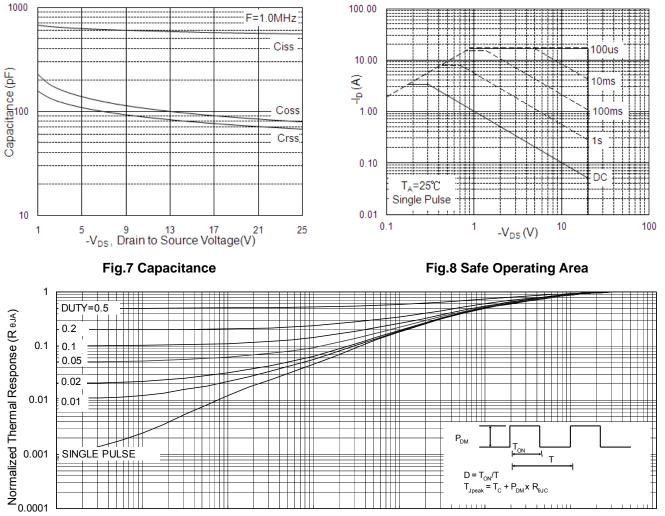


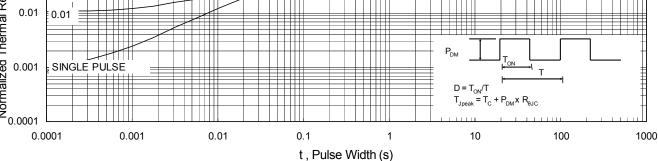
Fig.6 Normalized  $R_{\text{DSON}}$  vs  $T_{\text{J}}$ 



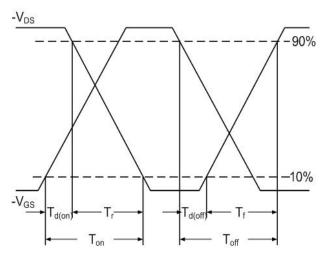
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P-Ch MOSFET

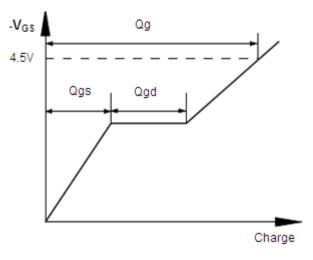




#### Fig.9 Normalized Maximum Transient Thermal Impedance







#### Fig.11 Gate Charge Waveform



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